



**Assembly Notes:**

Built on PMP10397 Rev\_A PWB

Ref. Des. > 99 have been added on the board

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Designed for: Public Release		Mod. Date: 28.09.2015	
Project Title: 85VAC to 528VAC Flyback with BJT switch			
Sheet Title: 85VAC to 528VAC Flyback with BJT switch			
Number: PMP10236	Rev: A	Assembly Variant: [No Variations]	
SVN Rev: Version control disabled		File: PMP10236 Rev_A Schematic.SchDoc	Sheet: 1 of 1
Drawn By: Roberto Scibilia		Contact: http://www.ti.com/support	Size: B
Engineer: Roberto Scibilia		© Texas Instruments, 2015	



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